

0400 06-27-01

JUL 02 2001

TRANSMITTAL OF FORMAL DRAWINGS

Docket No.  
FIS9-2000-0372-US1

In Re Application Of: S. Sundar Kumar Iyer et al.

#112  
1/12/04

Serial No.	Filing Date	Batch No.	Examiner	Art Unit
09/878,556	June 11, 2001	Unassigned	Unassigned	Unassigned

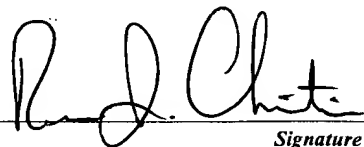
Invention: METHOD OF FORMING VARIABLE OXIDE THICKNESSES ACROSS SEMICONDUCTOR CHIPS

Address to:  
Assistant Commissioner for Patents  
Washington, D.C. 20231

Transmitted herewith are:

2 sheets of formal drawing(s) for this application.

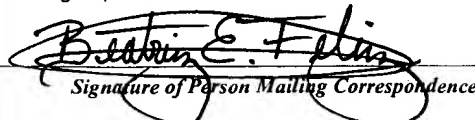
Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c) on the reverse side of the drawing.

  
Signature

Ross J. Christie, Esq.  
Registration No.: 47,492  
CANTOR COLBURN LLP  
101 Merritt 7  
Corporate Park  
Norwalk, CT 06856  
Phone: (203) 849-8266

Dated: June 28, 2001

I certify that this document and attached formal drawings are being deposited on 6/28/01 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

  
Signature of Person Mailing Correspondence

Beatriz E. Feliz

Typed or Printed Name of Person Mailing Correspondence

**CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)**

Applicant(s): S. Sundar Kumar Iyer et al.

Docket No.

FIS9-2000-0372-US1

Serial No.

09/878,556

Filing Date

June 11, 2001

Examiner

Unassigned

Group Art Unit

Unassigned

Invention: Method of Forming Variable Oxide Thicknesses Across Semiconductor Chips

I hereby certify that this Transmittal of Formal Drawings

(Identify type of correspondence)

is being deposited with the United States Postal Service as first class mail in an envelope addressed to: The

Commissioner of Patents and Trademarks, Washington, D.C. 20231-0001 on

June 28, 2001

(Date)

Beatriz E. Feliz

(Typed or Printed Name of Person Mailing Correspondence)



(Signature of Person Mailing Correspondence)

Note: Each paper must have its own certificate of mailing.